

Super Workstation SYS-730A-I

Key Applications

Rendering, CAD, Multimedia/Digital Content creation, Engineering/scientific research,

Key Features

- 3rd Gen Intel[®] Xeon[®] Scalable processor support;
- Intel[®] C621A Chipset;
- 5 PCIe 4.0 x16, 1 PCIe 4.0 x8, 2 NVMe M.2 slots;
- up to 4x NVMe SSD support with opitonal cables and converter trays; 4x internal 3.5" SATA rotating drive bays for easy access; 2x 5.25" peripheral drive bays;
- Compact and quiet operation; New front bezel with keylock for added security;



security,	
Form Factor	Mid-Tower Rackmount
	Enclosure: 193 x 424 x 525.3mm (7.6" x 16.7" x 20.68")
	Package: 304 x 543 x 642mm (11.97" x 21.38" x 25.28")
Processor	3rd Gen Intel® Xeon® Scalable processors
	Dual Socket LGA-4189 (Socket P+) supported
	TDP up to 270W; 3 UPI
	(Certain CPU SKUs are conditionally supported, please contact Supermicro Technical Support for additional
	information about specialized system optimization)
System Memory	16 DIMM slots
	Up to 4 TB ECC RDIMM, DDR4-3200MHz
	Up to 4 TB ECC LRDIMM, DDR4-3200MHz
	Up to 512GB Intel® DCPMM, DDR4-3200MHz
Drive Bays	4x 3.5" SATA (NVMe optional) drive bays (4x 2.5" NVMe hybrid)
	2 M.2 NVMe
Expansion Slots	5 PCIe 4.0 x16 FHFL slot(s)
	1 PCIe 4.0 x8 FHHL slot(s)
On-Board Devices	SATA: SATA3 (6Gbps); RAID 0/1/5/10 support
	Chipset: Intel® C621A
	Network Connectivity: 2x 1GbE port(s)
	IPMI: Support for Intelligent Platform Management Interface v.2.0
	IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
Input / Output	SATA: 2 SuperDOM port(s)
	LAN: 2 RJ45 1GbE (IPMI Shared on LAN port1)
	USB: 6 USB 3.2 Gen1 port(s) (4 Rear_USB; 2 Front_USB)
	1 USB 3.2 Gen2 port(s) (1 Front_USB)
	Video: 1 VGA port(s)







System Cooling	2x 12cm heavy duty fan(s)
Power Supply	1200W PS2 Multi-output power supply
	Dimension (W x H x L): 150 x 86 x 185 mm
	Output Type: Modular Cable Output
System BIOS	BIOS Type: AMI 32MB SPI FLASH ROM
Management	SuperDoctor® 5; Watch Dog; NMI; SUM; KVM with dedicated LAN; SPM; SSM; IPMI 2.0; Redfish API
PC Health Monitoring	Temperature: Monitoring for CPU and chassis environment
	Thermal Control for fan connectors
	FAN: Status monitor for speed control
	Pulse Width Modulated (PWM) fan connectors
	CPU: Monitors for CPU Cores, Chipset Voltages, Memory.
Dimensions and Weight	Height: 16.7" (424 mm)
	Width: 7.6" (193 mm)
	Depth: 20.68" (525.3 mm)
	Gross Weight: 30 lbs (13.61 kg)
	Net Weight: 27 lbs (12.25 kg)
	Packaging: 21.38" (H) x 11.97" (W) x 25.28" (D)
	Available Color: black
Operating Environment	Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F)
	Non-operating Temperature: -40°C to 60°C (-40°F to 140°F)
	Operating Relative Humidity: 8% to 90% (non-condensing)
	Non-operating Relative Humidity: 5% to 95% (non-condensing)
Motherboard	Super X12DAI-N6
Chassis	CSE-735D4-1K26B